

PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
Ajaykumar R. Jain	05/15/2012
RECEIVING PARTY DATA	
Name:	Versatilis LLC
Street Address:	488 Ridgefield Road
City:	Shelburne
State/Country:	VERMONT
Postal Code:	05482
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	13510427
CORRESPONDENCE DATA	
Fax Number:	(802)862-7512
Phone:	802-863-2375
Email:	patip@drm.com
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent via US Mail.</i>	
Correspondent Name:	Morgan S. Heller II
Address Line 1:	199 MAIN STREET
Address Line 2:	P O BOX 190
Address Line 4:	BURLINGTON, VERMONT 05402-0190
ATTORNEY DOCKET NUMBER:	11071-010USU1
NAME OF SUBMITTER:	Morgan S. Heller II
Total Attachments: 1 source=Assignment_11071010USU1#page1.tif	

OP \$40.00 13510427

Atty. Docket No.: 11071-010USU1

ASSIGNMENT

Whereas, I, Ajaykumar R. Jain, residing in San Carlos, California, have invented a certain new and useful

STATIC-ELECTRICAL-FIELD-ENHANCED SEMICONDUCTOR-BASED DEVICES AND METHODS OF ENHANCING SEMICONDUCTOR-BASED DEVICE PERFORMANCE

and have filed therefor U.S. Provisional Application No. 61/283,265, on December 2, 2009, U.S. Provisional Application No. 61/283,356 on December 3, 2009, U.S. Provisional Application No. 61/396,022 on May 21, 2010, U.S. Provisional Application No. 61/343,932 on May 6, 2010, U.S. Provisional Application No. 61/343,931 on May 6, 2010, and U.S. Provisional Application No. 61/396,020 on May 21, 2010 (hereinafter, "Applications");

And whereas Versatilis LLC, a limited liability company of Vermont, having a place of business at 488 Ridgefield Road, Shelburne, VT 05482 (hereinafter, "Assignee"), desires to acquire the entire right, title, and interest in the Applications and inventions, and to any United States and foreign patents to be obtained therefor, and to any United States, international, and foreign patent applications to be filed thereon;

Now therefore, for good and valuable consideration, receipt whereof is hereby acknowledged, I, the above-named inventor, hereby sell, assign, and transfer to Assignee, its successors and assigns, the entire right, title, and interest in the Applications and inventions therein disclosed for the United States and foreign countries, and all rights of priority resulting from the filing of the Applications; and I hereby agree that Assignee may file one or more international applications and apply for foreign Letters Patent on said inventions; and I request the Commissioner for Patents of the United States Patent and Trademark Office and the authorized official in each respective foreign patent office to issue any Letters Patent granted upon the inventions set forth in the Applications to Assignee; and I will execute all papers necessary in connection with the United States, international, and foreign applications when called upon to do so by Assignee.

I, the above-named, hereby covenant that no assignment, sale, agreement, or encumbrance has been or will be made or entered into which would conflict with this assignment.

Executed at San Carlos, CA, this 15th day of May, 2012.
(City) (State)

Ajay R. Jain
Ajaykumar R. Jain

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